



4 Layers 3.0mm Thick Multilayer PCB with Shengyi TG170 Sheet for Heavy Gold Motherboard

Basic Information

Place of Origin: China
Brand Name: GS
Model Number: GS430
Minimum Order Quantity: 1 PCS

• Price: USD+negotiable+pcs

Packaging Details: 20*20*5mm
Delivery Time: 1-7 days
Payment Terms: T/T

• Supply Ability: 1+pcs+per days



Product Specification

Highlight: Multilayer Circuit Board 4 Layers,
 Multilayer Circuit Board 3.0mm

PCB Manufacturing Multilayer Circuit Board 4 Layers 3.0mm Thick Motherboard

High-quality 4-layer multilayer PCB with 3.0mm thickness, manufactured using Shengyi TG170 sheet material with heavy gold plating for superior durability and conductivity.



















Multilayer PCB PCB fabrication process HDI PCB PCB assembly services Flexible circuit boards Rigid-flex PCBs PCB design software Printed circuit board manufacturing PCB etching techniques Solder mask application PCB prototyping Copper plating in PCBs PCB layer stackup Via technology in PCBs Prototype PCB manufacturing PCB testing methods Surface mount technology (SMT) PCBs Thermal management in PCBs PCB material types (FR-4, Rogers) Rapid PCB manufacturing





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